



## 40V/50A N-Channel Advanced Power MOSFET

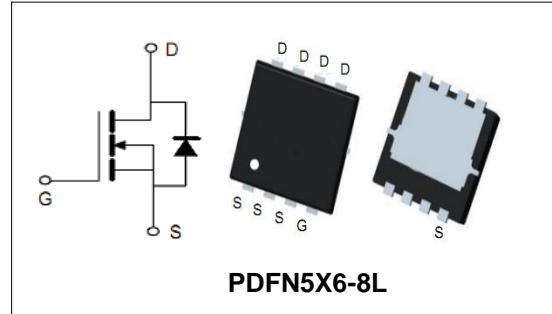
**Features**

- Fast switching capability
- Robust design with better EAS performance
- Ultra-low on-resistance

BVDSS	40	V
ID	50	A
RDSON@VGS=10V	5.5	mΩ
RDSON@VGS=4.5V	7.5	mΩ

**Applications**

- Battery Management System
- Motor Drivers
- DC-DC Converter

**Order Information**

Product	Package	Marking	Reel Size	Reel	Carton
PGN04N070	PDFN5X6-8L	PGN04N070	13inch	5000PCS	50000PCS

**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit
<b>Common Ratings (TC=25°C Unless Otherwise Noted)</b>			
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	40	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
T <sub>J</sub>	Maximum Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
I <sub>S</sub>	Diode Continuous Forward Current	TC =25°C	50
<b>Mounted on Large Heat Sink</b>			
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note1)	45.5	mJ
I <sub>DM</sub>	Pulse Drain Current Tested (Silicon Limit) (Note2)	TC =25°C	200
I <sub>D</sub>	Continuous Drain current	TC =25°C	50
P <sub>D</sub>	Maximum Power Dissipation	TC =25°C	34
R <sub>θJC</sub>	Thermal Resistance Junction-to-Case (Note3)		° C/W

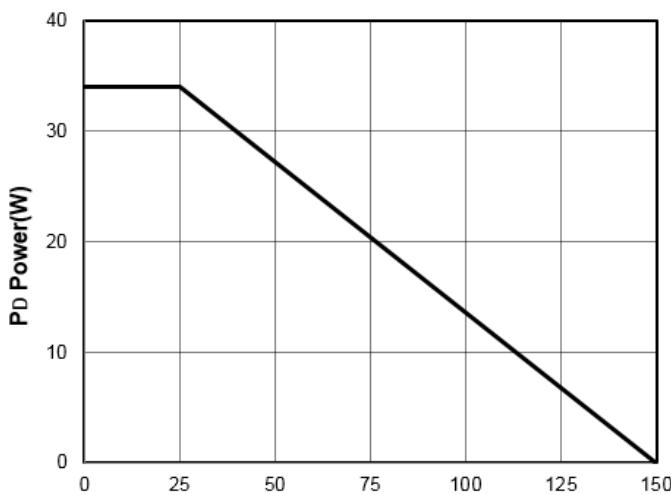
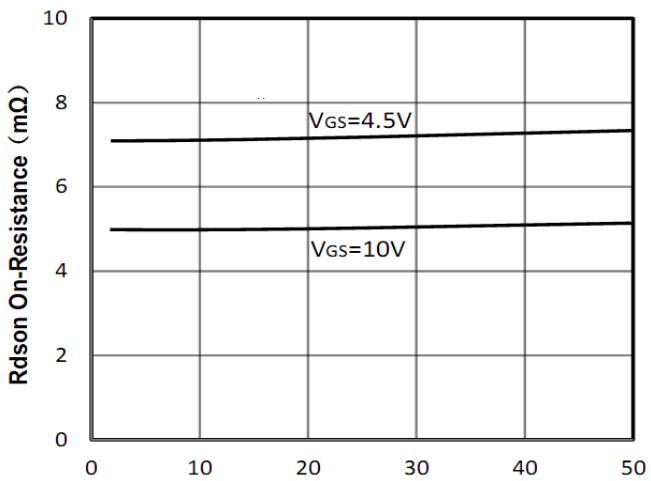
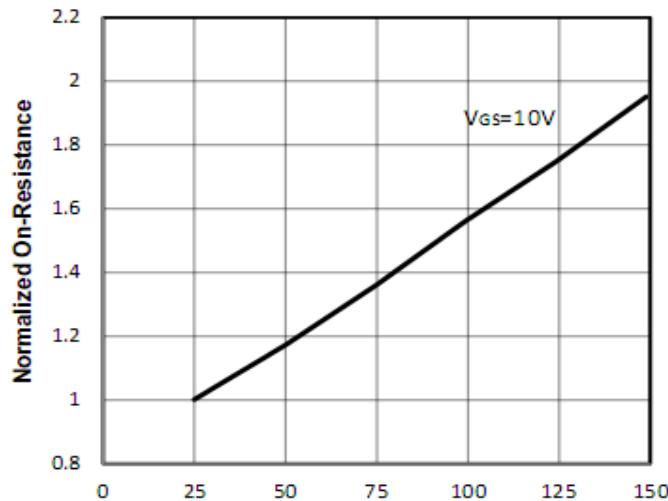
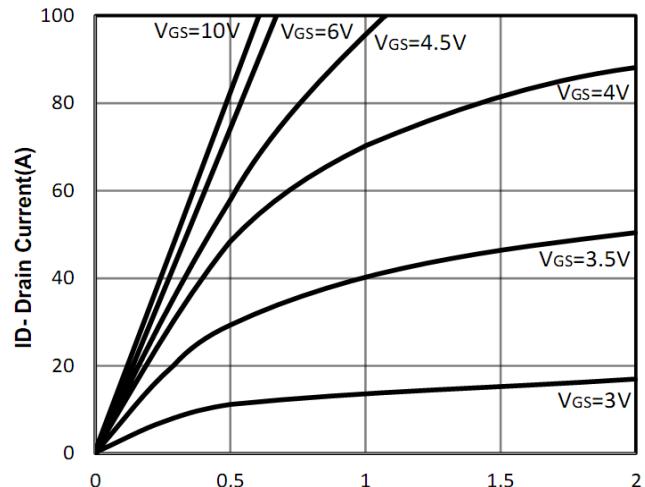
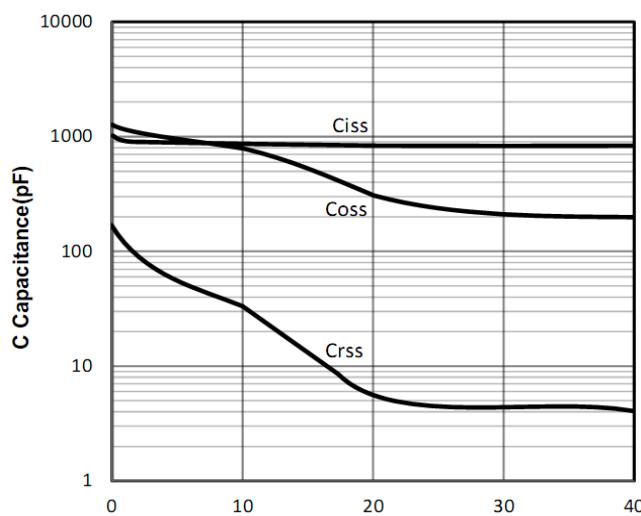
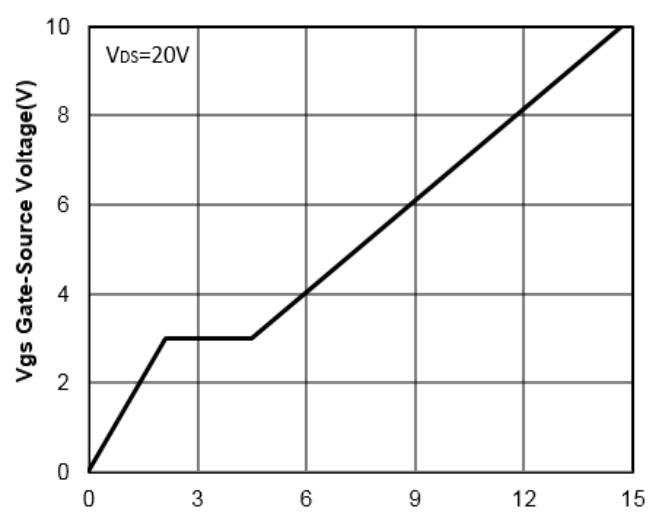


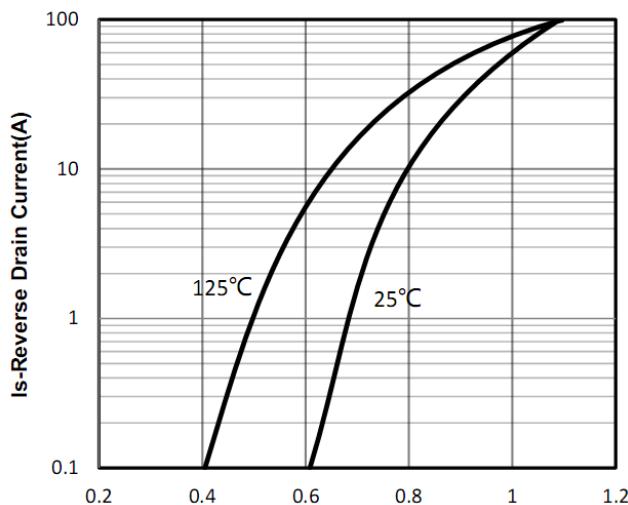
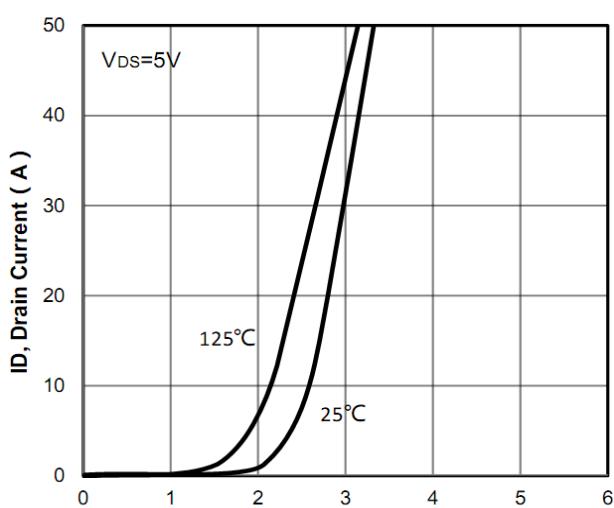
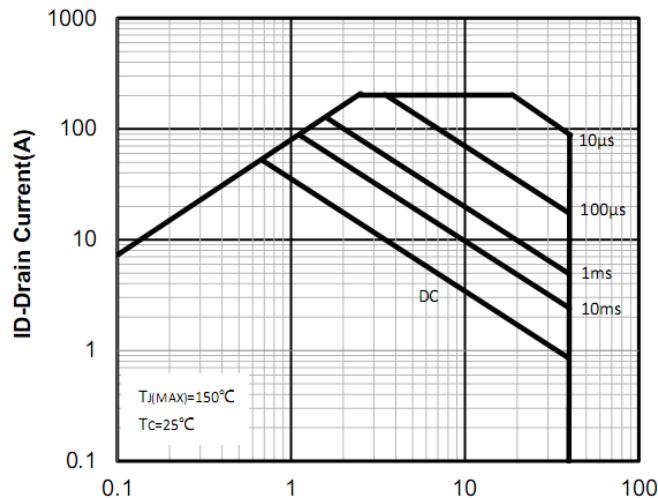
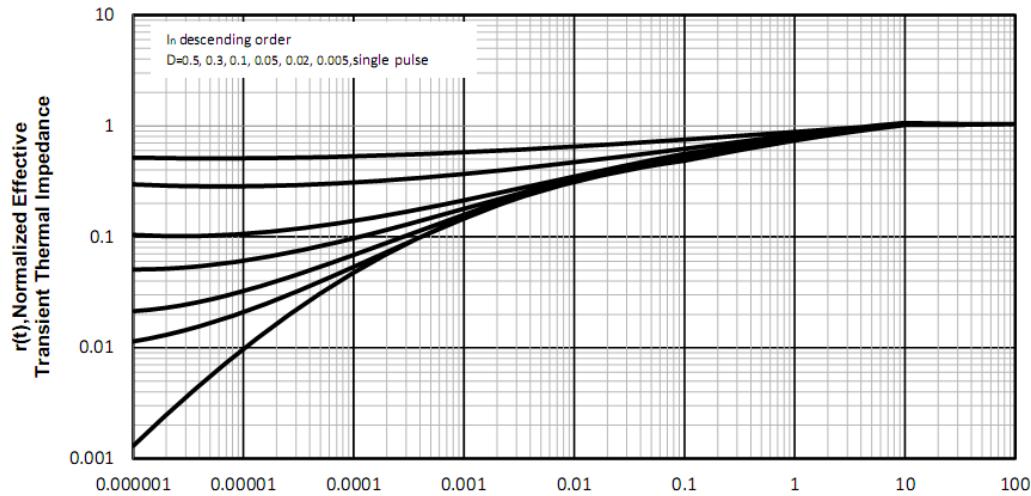
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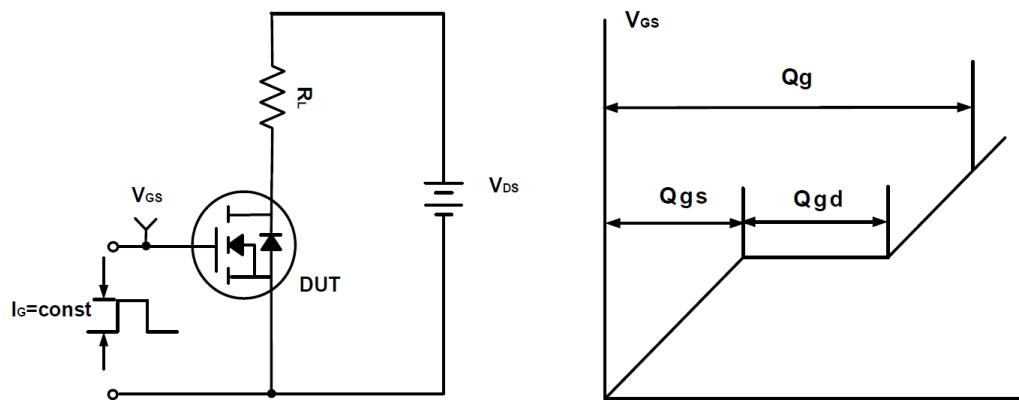
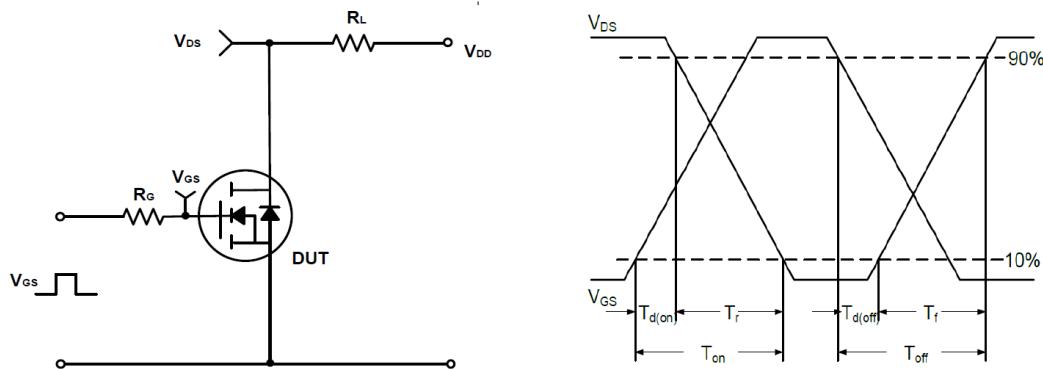
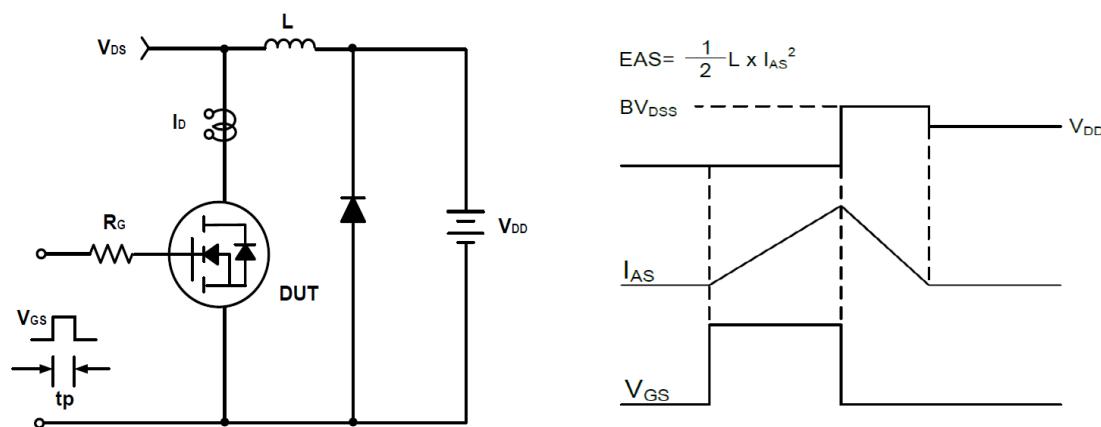
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)</b>						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	$VGS=0V$ $ID=250\mu A$	40	--	--	V
$I_{DSS}$	Zero Gate Voltage Drain current( $T_c=25^\circ C$ )	$VDS=40V$ , $VGS=0V$	--	--	1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$VGS=\pm 20V$ , $VDS=0V$	--	--	$\pm 100$	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$VDS=VGS$ , $ID=250\mu A$	1	1.8	2.5	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note4)	$VGS=10V$ , $ID=20A$	--	5.5	7	$m\Omega$
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note4)	$VGS=4.5V$ , $ID=20A$	--	7.5	10	$m\Omega$
<b>Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated) (Note5)</b>						
$C_{iss}$	Input Capacitance	$VDS=20V$ , $VGS=0V$ , $F=1MHz$	--	863	--	pF
$C_{oss}$	Output Capacitance		--	309	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	5.8	--	pF
$Q_g$	Total Gate Charge	$VDS=20V$ , $ID=20A$ , $VGS=10V$	--	14.7	--	nC
$Q_{gs}$	Gate-Source Charge		--	2.1	--	nC
$Q_{gd}$	Gate-Drain Charge		--	2.5	--	nC
$R_G$	Reverse Transfer Capacitance	$F=1MHz$	--	3.1	--	$\Omega$
<b>Switching Characteristics (Note5)</b>						
$t_{d(on)}$	Turn-on Delay Time	$VDS=20V$ , $RL=1\Omega$ , $RG=1.6\Omega$ , $VGS=10V$	--	5.8	--	nS
$t_r$	Turn-on Rise Time		--	49	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	17	--	nS
$t_f$	Turn-off Fall Time		--	4.9	--	nS
<b>Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated)</b>						
$V_{SD}$	Forward on voltage	$IS=20A$ , $VGS=0V$	--	--	1.2	V
$t_{rr}$	Reverse Recovery Time	$VDD=20V$ , $ID=20A$ , $Di/dt=100A/us$	--	28.2	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	15	--	nc

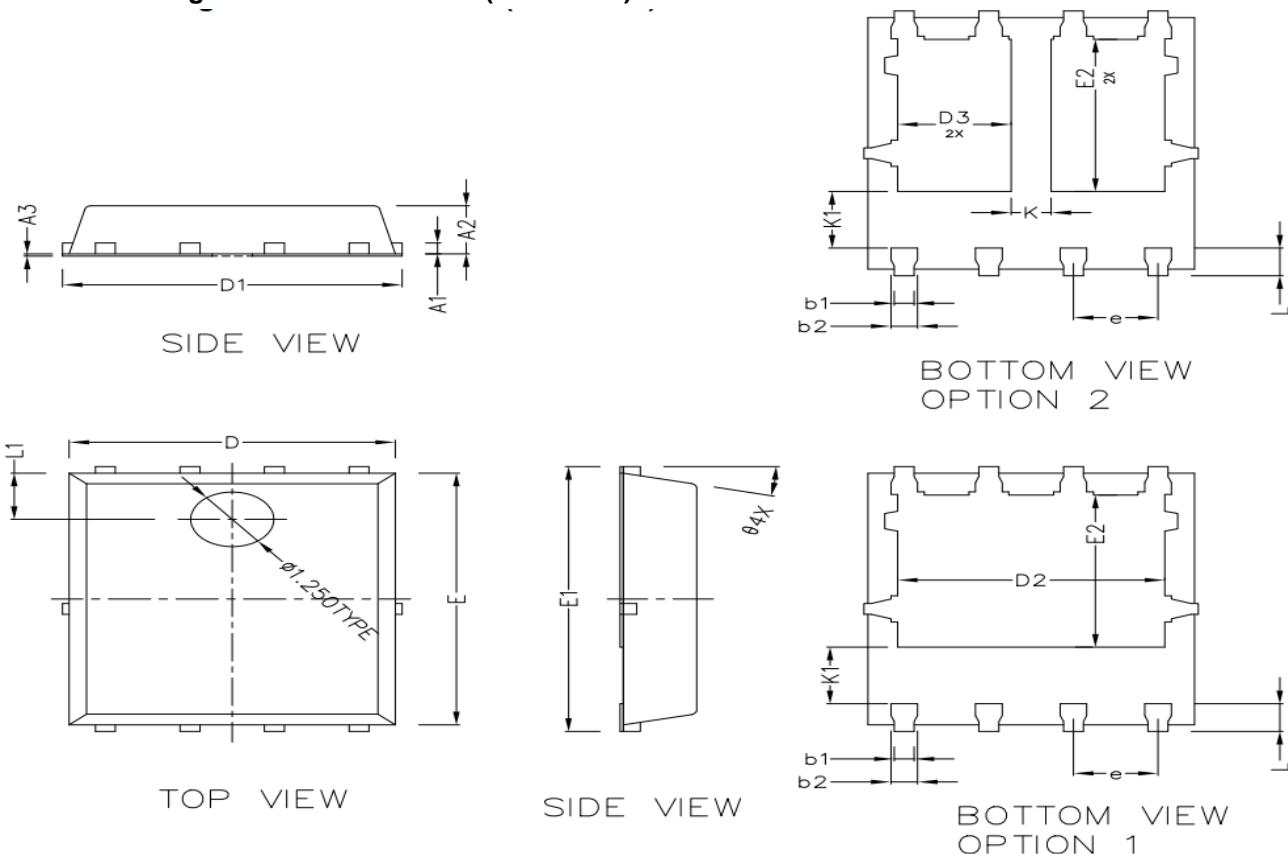
Note:

1. Limited by  $TJ_{max}$ , starting  $TJ = 25^\circ C$ ,  $RG = 25\Omega$ ,  $VDS = 20V$ ,  $VGS = 10V$ . Part not recommended for use above this value.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
4. Pulse Test: pulse width  $\leq 300$  us, duty cycle  $\leq 2\%$ .
5. Guaranteed by design, not subject to production testing.

**40V/50A N-Channel Advanced Power MOSFET**
**Typical Performance Characteristics**

**Figure1: TJ Junction Temperature (°C)**

**Figure2: ID Drain Current (A)**

**Figure3: TJ Junction Temperature (°C)**

**Figure4: VDS Drain-Source Voltage (V)**

**Figure5: VDS Drain-Source Voltage (V)**

**Figure6: Qg Gate Charge (nC)**

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**Figure7: Vsd Source-Drain Voltage (V)**

**Figure8: Vgs Gate-Source Voltage (V)**

**Figure9: Vsd Drain -Source Voltage (V)**

**Figure10: Square Wave Pulse Duration (sec)**

**40V/50A N-Channel Advanced Power MOSFET**
**Test Circuit and Waveform:**

**Figure A Gate Charge Test Circuit & Waveforms**

**Figure B Switching Test Circuit & Waveforms**

**Figure C Unclamped Inductive Switching Circuit & Waveforms**

**40V/50A N-Channel Advanced Power MOSFET**
**PDFN5X6-8L Package Outline Dimensions (Units: mm)**


COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A1		0.254 BSC	
A2	1.000	1.100	1.200
A3	0.005	—	0.020
b1	0.250	0.300	0.350
b2	0.350	0.400	0.450
D	4.800	4.900	5.000
D1	5.000	5.100	5.200
D2	3.910	4.010	4.110
D3	1.605	1.705	1.805
E	5.650	5.750	5.850
E1	5.950	6.050	6.150
E2	3.375	3.475	3.575
e	1.270 TYPE		
L	0.530	0.630	0.730
L1	1.00REF		
θ	13° TYPE		
K	0.600 REF		
K1	1.235 REF		